

#### Continental Device India Limited

An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company





## **SOT-23 Formed SMD Package**

CMBTA92 **CMBTA93** 

## SILICON EPITAXIAL TRANSISTORS

P-N-P transistor

#### Marking

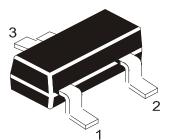
CMBTA92 = 2DCMBTA93 = 2E

#### Pin configuration

1 = BASE

2 = EMITTER 3 = COLLECTOR





#### ABSOLUTE MAXIMUM RATINGS

Collector has valtage (onen emitter)	17	_
Collector-base voltage (open emitter)	$-V_{CBO}$	) 1.
Collector-emitter voltage (open base)	$-V_{CEO}$	1
Emitter-base voltage (open collector)	$-V_{EBO}$	1
Collector current (d.c.)	$-I_C$	I
Total power dissipation up to $T_{amb} = 25  ^{\circ}C$	$P_{tot}$	
D.C. current gain		
$-I_C = 10 \text{ mA}; -V_{CE} = 10 \text{ V}$	$h_{FE}$	I
Transition frequency at $f = 100 \text{ MHz}$		
$-I_C = 10 \text{ mA}; -V_{CE} = 20 \text{ V}$	$f_T$	1
Collector-base capacitance at $f = 1$ MHz		
$IE = 0$ ; $-V_{CB} = 20 V$	$C_{cb}$	r

	<b>CMB</b>	TA92			A 93	•
$-V_{CBO}$	max.	300			200	V
$-V_{CEO}$	max.	<i>300</i>			200	V
$-V_{EBO}$	max.		5	i		V
$-I_C$	max.		50	00		mΑ
$P_{tot}$			25	50		mW
$h_{FE}$	min.		4	0		
$f_T$	min.		5	0		MHz
$C_{cb}$	max.	6			8	рF

## CMBTA92 CMBTA93

200 V

## **RATINGS** (at $T_A = 25^{\circ}C$ unless otherwise specified) Limiting values

		CMBT A 92	2 A9	3
Collector-base voltage (open emitter)	$-V_{CBO}$	max. 300	200	$\bar{\theta} V$
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 300	) 200	0 V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	5	V
Collector current (d.c.)	$-I_C$	max.	<i>500</i>	mA
Total power dissipation up to $T_{amb} = 25 ^{\circ}C$	$P_{tot}$	max	250	mW
Storage temperature	$T_{stg}$		−55 to +150	$^{\circ}$ $C$
Junction temperature	Τj	max.	<i>150</i>	$^{\circ}$ $C$

#### THERMAL CHARACTERISTICS

$$T_{j} = P (R_{th \ j-t} + R_{th \ t-s} + R_{th \ s-a}) + T_{amb}$$
Thermal resistance
from junction to ambient
 $R_{th \ j-a}$ 
500 K/W

## **CHARACTERISTICS** (at $T_A = 25^{\circ}C$ unless otherwise specified)

Collector-emitter breakdown voltage  $-I_C = 1 \text{ mA}$ ;  $I_B = 0$   $-V_{(BR)CEO} \text{ min.}$  300 Collector-base breakdown voltage

Conector-base breakdown voltage			
$-I_C = 100 \ \mu A; I_E = 0$	-V <sub>(BR)CBO</sub> min. 300		200 V
Collector cut-off current			
$-V_{CB} = 200 \ V; I_E = 0$	-I <sub>CBO</sub> тах. 0.25		- μ <i>A</i>
$-V_{CB} = 160 \ V; I_E = 0$	-I <sub>CBO</sub> max. –		$0.25~\mu A$
Emitter-base breakdown voltage			
$-I_E = 100 \ \mu A; I_C = 0$	$-V_{(BR)EBO}$ min.	5	V
Emitter cut-off current			

Ellitter cut-on current			
$I_C = 0$ ; $-V_{BE} = 3 V$ ;	$-I_{EBO}$	max. 0.1	<i>0.1</i> m <i>A</i>
Collector-base capacitance at f= 1 MHz			
$I_E = 0$ ; $-V_{CB} = 20 V$	$C_{cb}$	<i>max.</i> 6	8 pF
Coturation valtages			

Saturation voltages
$$-I_{C} = 20 \text{ mA}; -I_{B} = 2 \text{ mA} \qquad -V_{CEsat} \quad \text{max. } 0.5 \qquad 0.5 \text{ V}$$

$$-I_{C} = 20 \text{ mA}; -I_{B} = 2 \text{ mA} \qquad -V_{BEsat} \quad \text{max. } 0.9 \qquad 0.9 \text{ V}$$
D.C. current gain
$$-I_{C} = 1 \text{ mA}; -V_{CE} = 10 \text{ V} \qquad \text{hrs.} \qquad \text{min.} \qquad 25$$

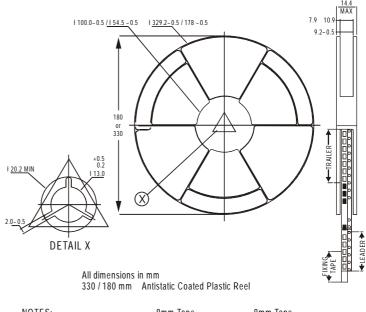
$-I_C = I \ mA; \ -V_{CE} = I0 \ V$	$h_{FE}$	min.	25
$-I_C = 10 \text{ mA; } -V_{CE} = 10 \text{ V}$	$h_{\!F\!E}$	min.	40
$-I_C = 30 \text{ mA; } -V_{CE} = 10 \text{ V}$	$h_{\!F\!E}$	min.	25

## **SOT-23 Formed SMD Package**

## 2.50 +/- 0.10 +/- 0.05 0.62 1.30+/-0.025 +/-0.05 0.62 +/-0.025 1.90 cL 3 - 0.05 - 1.30 +/- 0.05 0.62 I← 0.62 0.08 0.08 MIN MIN PARTING LINE RO.08 0.06 0.21

2.50 +/-0.10

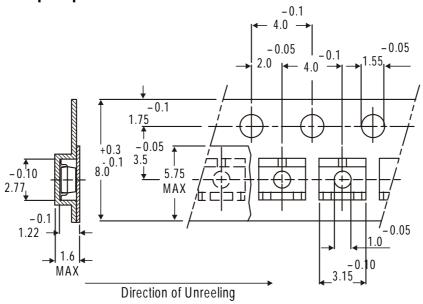
# SOT-23 Package Reel Information Reel specifications for Packing (13"/7" reels)



 NOTES:
 8mm Tape
 8mm Tape
 Size of Reel
 Size of Reel
 Size of Reel
 180 mm (7")
 180 mm (7")
 180 mm (7")
 3,000 Pcs
 3,000 Pcs

- 1. The bandolier of 330 mm reel contains at least 10,000 devices.
- 2. The bandolier of 180 mm reel contains at least 3,000 devices.
- No more than 0.5% missing devices / reel. 50 empty compartments for 330 mm reel. 15 empty compartments for 180 mm reel.
- Three consecutive empty places might be found provided this gap is followed by 6 consecutive devices.
- The carrier tape (leader) starts with at least 75 empty positions (equivalent to 330 mm). In order to fix the carrier tape a self adhesive tape of 20 to 50 mm is applied. At the end of the bandolier at least 40 empty positions (equivalent to 160 mm) are there.

## **Tape Specification for SOT-23 Surface Mount Device**



## **Packing Detail**

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
S0T-23 T&R	3K/reel	J 1	3" x 7.5" x 7.5" 9" x 9" x 9"	12.0K 51.0K	17" x 15" x 13.5" 19" x 19" x 19"	192.0K 408.0K	12 kgs 28 kgs
	10K/reel	415 gm/10K pcs	13" x 13" x 0.5"	10.0K	17" x 15" x 13.5"	300.0K	16 kgs

#### **Customer Notes**

#### **Component Disposal Instructions**

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
  - 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

#### **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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